Panasonic

LNA2801L

GaAlAs on GaAs Infrared Light Emitting Diode

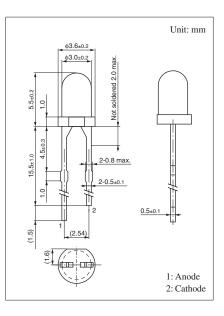
For optical control systems

Features

- High-power output, high-efficiency: $I_e = 6 \text{ mW/sr} (\text{min.})$
- Emitted light spectrum suited for silicon photodetectors
- · Good radiant power output linearity with respect to input current
- \$\$ plastic package

Absolute Maximum Hatings $T_a = 25$ C							
Parameter	Symbol	Rating	Unit				
Reverse voltage	V _R	3	V				
Forward current	$I_{\rm F}$	50	mA				
Pulse forward current *	I _{FP}	1	А				
Power dissipation	P_{D}	75	mW				
Operating ambient temperature	T _{opr}	-25 to +85	°C				
Storage temperature	T _{stg}	-40 to +100	°C				





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Unit

Note) *: f = 100 Hz, Duty Cycle = 0.1%

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Parameter	Symbol	Conditions	Min	
Forward voltage	V _F	$I_F = 50 \text{ mA}$		
Reverse current	I _R	$V_R = 3 V$		
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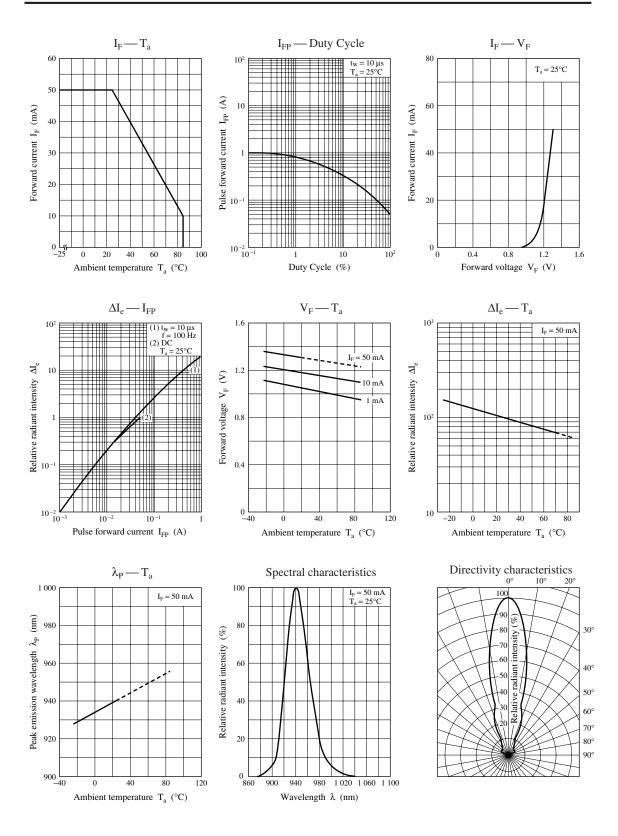
Electrical-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

1.3 1.5 V 10 μΑ Center radiant intensity I_e $I_F = 20 \text{ mA}$ 6 mW/sr Peak emission wavelength $\lambda_{\rm P}$ $I_F = 50 \text{ mA}$ 940 nm $I_F = 50 \text{ mA}$ Spectral half band width Δλ 50 nm Terminal capacitance C_t $V_R = 0 V, f = 1 MHz$ 35 pF 0 θ Half-power angle The angle when the radiant power is halved 15

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

2. Cutoff frequency: 1 MHz

 $f_C: 10 \times \log \frac{P_O \text{ at } f = f_C}{P_O \text{ at } f = 50 \text{ kHz}} = -3$



▲Caution for Safety

This product contains Gallium Arsenide (GaAs).

GaAs powder and vapor are hazardous to human health if inhaled or ingested. Do not burn, destroy, cut, cleave off, or chemically dissolve the product. Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

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/ € DANGER

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